Si4435DDY

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Vishay Siliconix

RoHS COMPLIANT

HALOGEN



PRODUCT SUMMARY						
V _{DS} (V)	-30					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0240					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.0350					
Q _g typ. (nC)	15					
I _D (A) ^d	-11.4					
Configuration	Single					

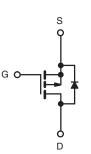
FEATURES

P-Channel 30 V (D-S) MOSFET

- TrenchFET® power MOSFET
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Load switches
- Battery switch



P-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free	Si4435DDY-T1-E3			
Lead (Pb)-free and halogen-free	Si4435DDY-T1-GE3			

ABSOLUTE MAXIMUM RATINGS (T _A =	= 25 °C, unless other	wise noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-30	N/	
Gate-source voltage		V _{GS}	± 20	V	
	T _C = 25 °C		-11.4		
Continuous drain surront $(T_{1} - 150 ^{\circ}\text{C})$	T _C = 70 °C] , [-9.1		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-8.1 ^{a, b}		
	T _A = 70 °C		-6.5 ^{a, b}	•	
Pulsed drain current	I _{DM}	-50	A		
	T _C = 25 °C		-4.1		
Continuous source-drain diode current	T _A = 25 °C	I _S	-2 ^{a, b}		
Avalanche current		I _{AS}	-20		
Single-pulse avalanche energy	L = 0.1 mH	E _{AS}	20	mJ	
	T _C = 25 °C		5		
Maximum power dissipation	T _C = 70 °C		3.2	14/	
	T _A = 25 °C	P _D	2.5 ^{a, b}	W	
	T _A = 70 °C	1 –	1.6 ^{a, b}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^{a, c}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum junction-to-foot	Steady state	R _{thJF}	20	25	-0/10	

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 10 s

c. Maximum under steady state conditions is 85 °C/W

d. Based on T_C = 25 $^\circ C$

S09-0863-Rev. C, 18-May-09

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static		•	•				
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-31	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	4.5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zaus and a selfan a durin a summer		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μΑ	
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$	-	-	-5		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge$ -10 V, V_{GS} = -10 V	-30	-	-	А	
Durin a companya da stata unaistana a 2	P	V _{GS} = -10 V, I _D = -9.1 A	-	0.0195	0.0240	<u> </u>	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -4.5 V, I _D = -6.9 A	-	0.0280	0.0350	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS} = -10 V, I _D = -9.1 A	-	23	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	1350	-	pF	
Output capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	215	-		
Reverse transfer capacitance	C _{rss}		-	185	-		
Total gate charge	0	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -9.1 \text{ A}$	-	32	50		
	Qg		-	15	25		
Gate-source charge	Q _{gs}	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -9.1 \text{ A}$	-	4	-	nC	
Gate-drain charge	Q _{gd}		-	7.5	-		
Gate resistance	R _g	f = 1 MHz	-	5.8	-	Ω	
Turn-on delay time	t _{d(on)}		-	10	15		
Rise time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{L} = 15 \Omega$	-	8	15		
Turn-off delay time	t _{d(off)}	$I_D\cong$ -1 A, V_{GEN} = -10 V, R_g = 1 Ω	-	45	70		
Fall time	t _f		-	12	25		
Turn-on delay time	t _{d(on)}		-	42	70	ns	
Rise time	t _r	V_{DD} = -15 V, R_L = 15 Ω	-	35	60		
Turn-off delay time	t _{d(off)}	$I_{D}\cong$ -1 A, V_{GEN} = -4.5 V, R_{g} = 1 Ω	-	40	70		
Fall time	t _f		-	16	30		
Drain-Source Body Diode Characteris	tics						
Continuous source-drain diode current	IS	T _C = 25 °C	-	-	-4.1	А	
Pulse diode forward current	I _{SM}		-	-	-50		
Body diode voltage	V _{SD}	$I_{\rm S}$ = -2 A, $V_{\rm GS}$ = 0 V	-	-0.75	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	34	60	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -2 A, di/dt = 100 A/μs,	-	22	40	nC	
Reverse recovery fall time	ta	T _J = 25 °C	-	11	-		
Reverse recovery rise time	t _b	1	-	23	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

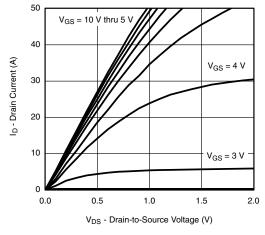
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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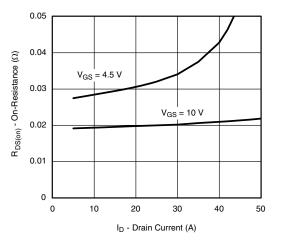


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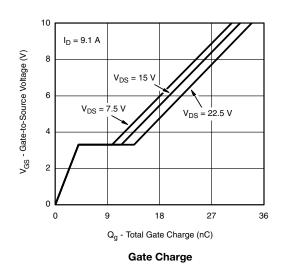
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

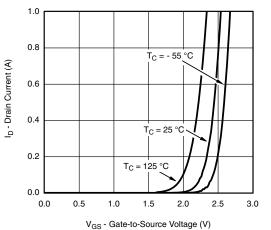


Output Characteristics

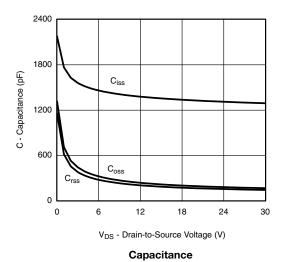


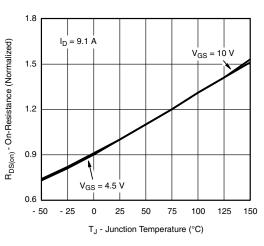
On-Resistance vs. Drain Current





Transfer Characteristics





On-Resistance vs. Junction Temperature

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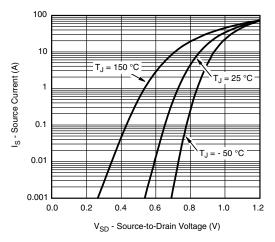
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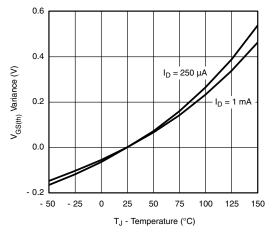
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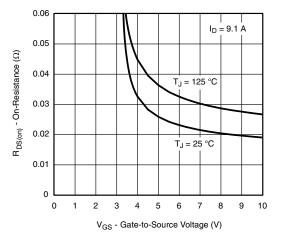
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



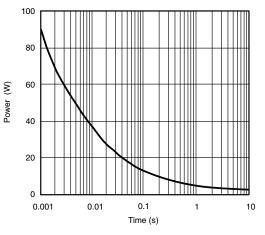
Source-Drain Diode Forward Voltage



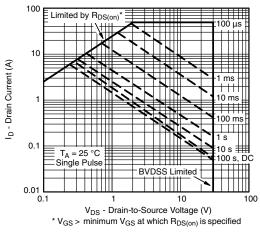




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

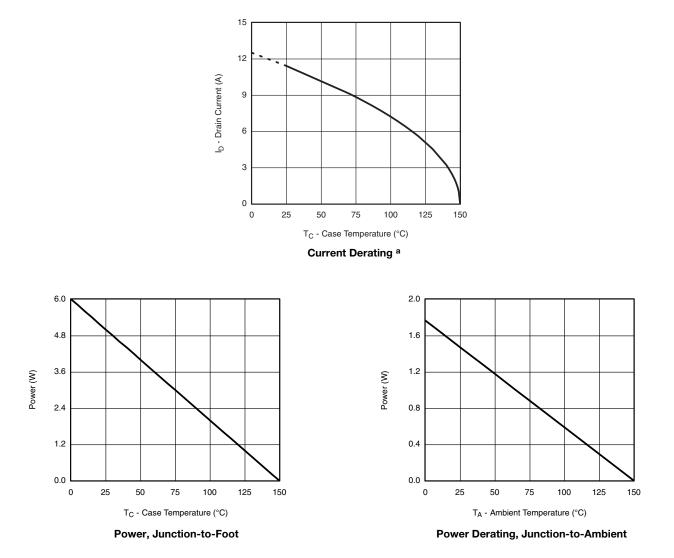






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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



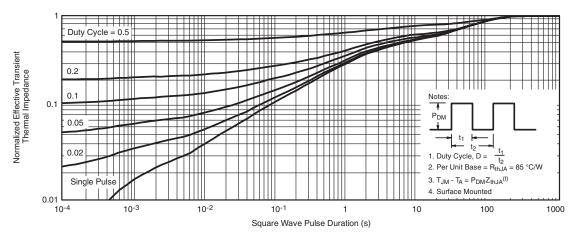
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

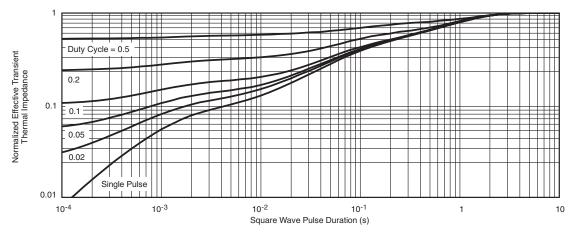


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?68841</u>.

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Package Information

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 01-Jul-2024